



Material Composition Sheet

Product: GS1528ACTAE3
 Package Type: SOIC-8 taped (250/reel)
 Manufacturer: Gennum Corporation

Date: 11-Dec-2006

Component	BOM	Weight of Component (mg)	Substance	Weight of Substance (mg)	Homogeneous Material	
					%	ppm
Chip		1.30	Al	0.01	0.76	7692
			Si	1.29	99.23	992308
			Sub-total:	1.30	99.99	1000000
Die Attach	Ablebond 84-1LMISR4	0.14	Aromatic Amine	0.01	7.14	71429
			Epoxy Resin	0.02	14.28	142857
			Silver	0.11	78.57	785714
			Sub-total:	0.14	99.99	1000000
Lead Finish External		1.41	Pb	0.35	24.82	248227
			Sn	1.06	75.17	751773
			Sub-total:	1.41	99.99	1000000
Lead Finish Internal		0.19	Ag	0.19	100.00	1000000
			Sub-total:	0.19	100.00	1000000
Leadframe	Olin 194FH	24.26	Cu	23.65	97.48	974856
			Fe	0.57	2.34	23495
			P	0.01	0.04	412
			Zn	0.03	0.12	1237
			Sub-total:	24.26	99.98	1000000
Marking Ink	Wieder W238	0.00		0.00	0.00	0
			Sub-total:	0.00	0.00	0
Mold Compound	EME 6300H	46.19	Antimony Trioxide	1.39	3.00	30093
			Brominated Epoxy Resin (1-3)	0.92	1.99	19918
			Carbon Black	0.14	0.30	3031
			Epoxy Cresol Novolac	7.39	15.99	159991
			Phenol/Novolac resin	2.63	5.69	56939
			Silica Fused	33.72	73.00	730028
			Sub-total:	46.19	99.97	1000000
Wires	SGA3	0.21	Au	0.21	100.00	1000000
			Sub-total:	0.21	100.00	1000000
Total:		73.70				

GENNUM CORPORATION

Mailing Address: P.O. Box 489, Stn. A, Burlington, Ontario, Canada L7R 3Y3
 Shipping Address: 970 Fraser Drive, Burlington, Ontario, Canada L7L 5P5
 Tel. +1 (905) 632-2996 Fax. +1 (905) 632-5946

www.gennum.com

The information contained in this document describes the homogeneous material composition of this product according to the definition set forth in the EU RoHS Directive 2002/95/EC. This information may have been derived from calculations based on information obtained from our suppliers. Gennum Corporation assumes no liability for any errors or omissions in this document. Gennum reserves the right to make changes to this document at any time without notice.